



# Data Sheet

Customer:	
Part No:	CLT5811
Sample No:	
Description:	5Ø Lamp Photo Transister
Item No:	

Customer						
Check	Inspection	Approval	Date			





## CLT5811

Unit : mm

## **1.Features**

- ► Lensed for high sensitivity
- ▶ High reliability and stable characteristics

## 2. Package Dimensions







## **3.** Absolute maximum ratings

Characteristic	Symbol	Ratings	Unit	
Collector-Emitter Voltage	VCEO	35	V	
Emitter-Collector Voltage	VECO	6	V	
Collector Current	Ic	20	mA	
Collector Power Dissipation	PD	75	mW	
Operating Temperature	Topr	-25~85	C	
Storage Temperature		-30~100	°C	
*1 Soldering Temperature	Tsol	$260^{\circ}$ C for 5 seconds		

\*1. Keep the distance more than 2.0mm from PCB to the bottom of LED package

## **4. Electrical Characteristics**

Character	istic	Symbol	Test Condition	Min	Тур	Max	Unit
Current Dark Current		CEO	Vceo=10V, Ee=0	- 0.05 0.5		0.5	μA
+1 Light Current		ICEL.	Vc∈=5V, E⊧≒1mW/cm²	4	-	7	mA
				7		10	
				10	-	12	
				12	-	14	
Current-Emitter Saturation Voltage		VCE(sat)	lc=0.5mA, Ee≒1mW/cm²	-	0.2	-	V
Switching Time	Rise Time	tr Vcc=10V, lc=1mA 2	Vcc=10V, lc=1mA R1=100Ω	2.5			
	Fall Time	tr		_	3.8	_	μs
Spectral Sensitivity		λ	_	750~1050		nm	
Peak Sensitivity Wav	elength	λP	_	- 880 -		nm	
Half angle		θ <sub>1/2</sub>	l⊧= 20mA	_	±20	_	deg

\*1. Tolerance =  $\pm 30\%$ 





## CLT5811

#### **5.**Characteristic Diagrams







## **6-1.** Soldering counditions

(1) The LEDs can be soldered in place using the reflow soldering method.

Ciellight does not make any guarantee on the LEDs after they have been assembled using the

dip soldering method.

(2) Recommended soldering conditions

Reflow Soldering			Hand Soldering		
	Lead Solder	Lead-free Solder	Temperature Soldering Time		
Pre-Heat	120~150℃	180~200°C		350°C Max. 3sec Max.	
Pre-Heat Time	120sec Max.	120sec Max.			
Peak Temperature	240°C Max.	260°C Max.			
Soldering Time	5sec Max.	5sec Max.		(one time only	
Condition	refer to profile 1	refer to profile 2			

\* Although the recommended soldering conditions are specified in the above table, reflow soldering at the lowest possible temperature is desirable for the LEDs.

\* A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

[Temperature-Profile (surface of circuit board)]

Use the conditions shown to the following figures.

#### < 1 : Lead Solder>

#### <2 : Lead-free Solder>



## 6-2. TTW Soldering









### 7. Caution on usage

7-1. Static electricity and surge will damage the LEDs It is recommended to take measures to prevent ESD problem (for example, grounding equipment and the human body, using grounded soldering iron and so on).

7-2. Be careful never to exceed , even momentarily, the absolute maximum ratings specified in the data sheet.

7-3. Ciellight will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit if use to exceed the absolute maximum ratings, or not keep the matters that demand special attention.

7-4. Store and use where there is no corrosive gas.

7-5. While the device is operational across the temperature range, functionality will with temperature. Specifications are stated only.

7-6. Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 8. Warranty period : One year after delivery.